

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. END920030022US1

Total Pages in this Submission

TO THE COMMISSIONER FOR PATENTS

Mail Stop Patent Application P.O. Box 1450 Alexandria, VA 22313-1450

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for a	an
invention entitled:	411
METHOD AND CERTICIPATE TO BE CAREED TO BE CA	

٧	TVC/IIIOT CITATICA.									
M A	METHOD AND STRUCTURE FOR SLEF HEALING CRACKS IN UNDERFILL MATERIAL BETWEEN AN I/C CHIP AND A SUBSTRATE BONDED TOGETHER WITH SOLDER BALLS									
and	and invented by:									
G	George H. Thiel ASSIGNEE NAME: International Business Machines Corporation ASSIGNEE RESIDENCE: Armonk, NY									
If a	CONT	rinu	ATION A	APF	PLICATION,	ched	ck appropria	ate box and supply	the requisite information:	
	Conf	tinua	tion [Divisional		Continua	tion-in-part (CIP)	of prior application No.:	
Whi	ich is a	a:								
	Conf	tinua	tion [Divisional		Continua	tion-in-part (CIP)	of prior application No.:	
Whi	ich is a	a:						•		
	Conf	inua	tion [Divisional		Continua	tion-in-part (CIP)	of prior application No.:	
Enc	losed	are:								
							Applic	ation Elements		
1	l. 🛭	Filir	ng fee a	s ca	alculated and	l tran	smitted as	described below		
2	2. 🛛	Spe	cificatio	n h	aving		10	pages and ir	ncluding the following:	
	a.	X	Descri	ptiv	e Title of the	Inve	ention			
	b.	\boxtimes	Cross	Ref	ferences to F	Relate	ed Applicati	ions (if applicable)		
	C.		—							
	d.								.~	
	d. Reference to Sequence Listing, a Table, or a Computer Program Listing Appendixe. Background of the Invention									
	f. Brief Summary of the Invention									
	g.									
	h.		Detailed Description							
	i.				•	Dala		,		
		()								
	j.	\boxtimes	Abstrac	ct o	f the Disclos	ure				

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4

		Application Elements (Continued)						
3.		Drawing(s) (when necessary as prescribed by 35 USC 113)						
	a.	⊠ Formal Number of Sheets 2						
	b.	☐ Informal Number of Sheets						
4.	X	Oath or Declaration						
	a.	☑ Newly executed (original or copy) ☐ Unexecuted						
	b.	☐ Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional application only)						
	c.	☑ With Power of Attorney ☐ Without Power of Attorney						
	d.	☐ <u>DELETION OF INVENTOR(S)</u> Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. 1.63(d)(2) and 1.33(b).						
5.		Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.						
6.		CD ROM or CD-R in duplicate, large table or Computer Program (Appendix)						
7.	\boxtimes	Application Data Sheet (See 37 CFR 1.76)						
8.		Nucleotide and/or Amino Acid Sequence Submission (if applicable, all must be included)						
	a.	☐ Computer Readable Form (CRF)						
	b.	☐ Specification Sequence Listing on:						
		i. CD-ROM or CD-R (2 copies); or						
		ii. 🔲 Paper						
	C.	☐ Statement(s) Verifying Identical Paper and Computer Readable Copy						
		Accompanying Application Parts						
9.	\boxtimes	Assignment Papers (cover sheet & document(s))						
10.		37 CFR 3.73(B) Statement (when there is an assignee)						
11.		English Translation Document (if applicable)						
12.	\boxtimes	Information Disclosure Statement/PTO-1449 Copies of IDS Citations (non-US)						
13.		Preliminary Amendment						
14.	\boxtimes	Return Receipt Postcard (MPEP 503) (Should be specifically itemized) (2)						
15.		Certified Copy of Priority Document(s) (if foreign priority is claimed)						
16.	\boxtimes	Certificate of Mailing						
		☐ First Class ☒ Express Mail (Specify Label No.):EV 342658919US						

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Accompanying Application Parts (Continued)

17.	Additional Enclosures (please identify below):
	Request That Application Not Be Published Pursuant To 35 U.S.C. 122(b)(2)
18.	Pursuant to 35 U.S.C. 122(b)(2), Applicant hereby requests that this patent application not be published pursuant to 35 U.S.C. 122(b)(1). Applicant hereby certifies that the invention disclosed in this application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication of applications 18 months after filing of the application.
	Warning
	An applicant who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice within the prescribed period shall result in the application being regarded as abandoned, unless it is shown to the satisfaction of the Director that the delay in submitting the notice was unintentional.

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Fee Calculation and Transmittal

		CLAIMS	AS FILED			
For	#Filed	#Allowed	#Extra		Rate	Fee
Total Claims	16	- 20 =	0	×	\$18.00	\$0.00
Indep. Claims 2 - 3 = 0 x \$86.00						
Multiple Dependent	Claims (check i	if applicable)				\$0.00
					BASIC FEE	\$770.00
OTHER FEE (spec	fy purpose)					\$0.00
		···	-		TOTAL FILING FEE	\$770.00
☑ Credit a☑ Charge☐ Charge	t to 37 C.F.R. 1.0	ng fees required in 37 C.F.R. 1.1	18 at the maili	ng of the	S and 1.17. Notice of Allowance, William A Signature I. Steinberg, Reg. No. 28,540 Doration / IP Law Dept. IQU	
·			E	-	h Street NY 13760 e: (607) 429-3979	-

cc: RECORDS

Fax No.:

(607) 429-5282

CERTIFICATE OF MA Applicant(s): Thiel	AILING BY "EXPRESS	MAIL" (37 CFR 1.10)	DOCKET NO. END920030022US1 (IEN-10-5752)					
Serial No. To be assigned	Group Art Unit							
Invention: METHOD AND STRUCTURE FOR SELF HEALING CRACKS IN UNDERFILL MATERIAL BETWEEN AN I/C CHIP AND A SUBSTRATE BONDED TOGETHER WITH SOLDER BALLS								
I hereby certify that the	I hereby certify that the following documents							
New Utility	Patent Application Trans	mittal						
Application 1	Data Sheet							
Patent Application comprising 5 pages of specification, 4 pages of claims, 1 page of Abstract and 2 sheet of drawings								
Declaration and Power of Attorney for Patent Application								
Assignment	Assignment and Recordation Cover Sheet							
IDS Submission Statement with 1449 Form and copies of *** citations(non-US)								
Two (2) Ack	nowledgement post card	s						
are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 10/16/03.								
Typed or Printed Name of Person Mailing Correspondence) (Signature of Person Mailing, Correspondence)								
EV 342658919 US ("Express Mail" Mailing Label Number)								